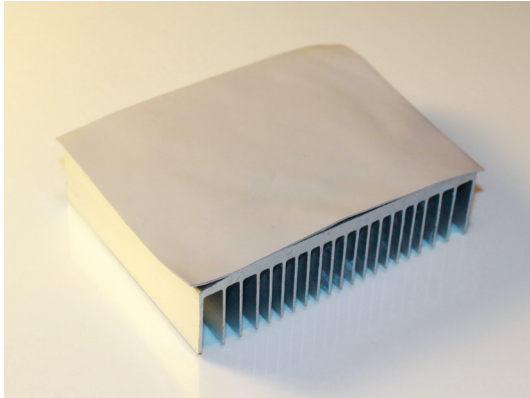


H48-6G

Thermal Conductive Pad



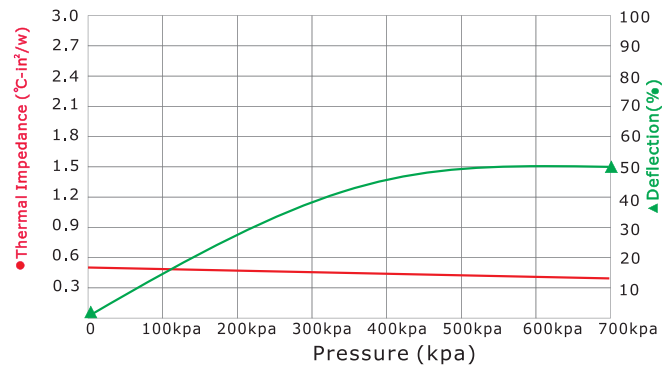
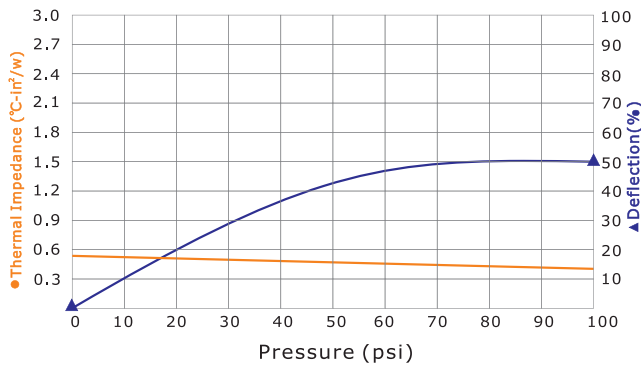
Features

- Very good thermal conductivity
- Soft and high compressibility
- Natural tack
- Easy to assemble
- Very good insulator

Applications

- Electronic components: IC / CPU / MOS
- LED / M/B / P/S / Heat Sink / LCD-TV / Notebook PC / PC / Telecom Device / Wireless Hub etc....
- DDR II Module / DVD Applications / Hand-Set applications etc...

Thermal Resistance V.S Pressure V.S Deflection



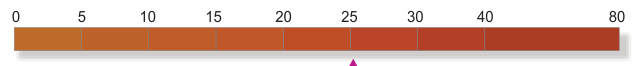
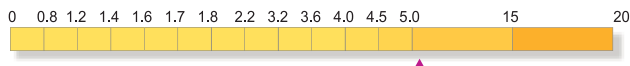
Properties

REACH Compliant

RoHS Compliant

Thermal Conductivity: 6 W/mK
(W/mK - Z Axis)

Hardness: 14 (Shore A)
(Shore A)



Testing sample thickness : 1.0 mm

In the thermal resistance vs pressure vs deflection charts H48-6G provides low thermal impedance. As the pressure increases the thermal impedance decreases. H48-6G provides good compliance and softness.

Property	H48-6G	Unit	Tolerance	Test Method
Colour	Grey	-	-	Visual
Thickness (Available thickness range)	0.3 - 5.0	mm	-	ASTM D374
	0.0118 - 0.1969	inch	-	ASTM D374
Thermal Conductivity	6	W/mK	-	ASTM D5470
Flammability Rating	V-0	-	-	UL 94
Dielectric Breakdown Voltage	>13	kV/mm	-	ASTM D149
Weight Loss	<1	%	-	ASTM E595
Specific Gravity	3.09	g/cm ³	±0.2	ASTM D792
Working Temperature	-40 to 200	°C	-	-
Volume Resistance	>10 ¹²	Ohm-cm	-	ASTM D257
Elongation	60	%	±13	ASTM D412
Tensile Strength	6	Kgf/cm ²	±2	ASTM D412
Standard Shape	-	Sheets 320-320mm	-	-
Hardness	25	Shore A	±5	ASTM D2240

Available with an adhesive backing



H48-6G - 15 - 20 - 3 - 1A, 20 4

1. Part Number
2. Size X-Y-Z
3. Adhesive backing - 0-None, 1A-one side, 2A-two sides
4. Quantity